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Nuclear Instruments and Methods in Physics Research, Section A: Accelerators, Spectrometers, Detectors and Associated Equipment, Vol. 831, 2016, p. 12-17 doi:10.1016/j.nima.2016.03.057

The final publication is available at https://doi.org/10.1016/j.nima.2016.03.057

Access to the published version may require subscription.

When citing this work, cite the original published paper.

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Permanent link to this version http://hdl.handle.net/11311/1007036

Direct detection of antiprotons with the Timepix3 in a new electrostatic selection beamline

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Abstract

We present here the first results obtained employing the Timepix3 for the detection and tagging of annihilations of low energy antiprotons. The Timepix3 is a recently developed hybrid pixel detector with advanced Time-of-Arrival and Time-over-Threshold capabilities and has the potential of allowing precise kinetic energy measurements of low energy charged particles from their time of flight. The tagging of the characteristic antiproton annihilation signature, already studied by our

group, is enabled by the high spatial and energy resolution of this detector. In this study we have used a new, dedicated, energy selection beamline (GRACE). The line is symbiotic to the AEgIS experiment at the CERN Antiproton Decelerator and is dedicated to detector tests and possibly antiproton physics experiments. We show how the high resolution of the Timepix3 on the Time-of-Arrival and Time-over-Threshold information allows for a precise 3D reconstruction of the annihilation prongs. The presented results point at the potential use of the Timepix3 in antimatter-research experiments where a precise and unambiguous tagging of antiproton annihilations is required.

1. Introduction

Antimatter experiments often make use of annihilation detectors, i.e. detectors dedicated to spatially and temporally resolve an annihilation event by the detection of annihilation products. To date, tracking detectors have always been employed to detect remote annihilations, i.e. annihilations happening at a distance from the detector planes. This allows to have the antimatter interactions happening in a separate environment from where the detector is located, thus relaxing the constraints on environmental parameters (mainly pressure and temperature) for the detector operation.

In the AEgIS experiment [1], [2] at the CERN Antiproton Decelerator (AD) [3], a silicon strip detector will be used for the first time as a direct annihilation detector. The detector will provide preliminary position information along with Time-of-Arrival (ToA) of a collimated antihydrogen beam, annihilating on the detector surface. Submicron-resolution will be then provided by a downstream emulsion detector, that will tag and reconstruct the single annihilation vertices, to be matched with single hits measured on the strip detector. The position information will be used to measure the small deflection from a straight path of a free-falling antihydrogen beam. This deflection is expected to be in the order of 20 μ m.

Along with the development of the strip detector, in its final stages, we are currently investigating ToA-capable thick pixel detectors, which could provide a stand-alone solution for antimatter detection and tagging in scenarios with more relaxed position resolution requirements. In the following sections we will present the results obtained using the Timepix3 readout ASIC (Application Specific Integrated Circuit) and a relatively thick silicon pixel sensor. The tests were aimed at validating for the first time a new slow antiproton extraction line (GRACE), that will be dedicated to detector test and interferometry study. The beamline employs electrostatic optics and is able to select antiprotons of ~keV energy. We further demonstrate the potential shown by the Timepix3 in its use as a direct-annihilation detector. These results complement previous works published by our group, employing different sensor technologies [4], [5], [6].

2. Antiproton annihilation physics

When antiprotons come to rest in Z>1 materials, they annihilate with a proton or a neutron of the atoms composing the material. The direct products of this annihilation are mesons (pions and kaons), resulting from a rearrangement of the quarks composing the antiproton and the proton or neutron. As some of these pions cross through the now destabilized nucleus, nuclear fragmentation may occur with the further production of heavy charged particles. The total energy available in an annihilation event (to be distributed between the pions' mass and the kinetic energies of the annihilation products) is given by the mass-to-energy equivalence of the antiproton and proton (or neutron) taking part in the annihilation (~2 GeV). Hence the energy of the products is usually in the order of few $\cdot 10^2$ MeV. A more detailed description of the process, together with estimated multiplicities of the different annihilation products in silicon, is provided in [4].

3. Experimental setup

3.1. The Timepix3

The Timepix3 is a data-driven hybrid pixel readout ASIC developed in the context of the Medipix3 collaboration [7]. The ASIC provides a readout matrix of 256×256 pixels, spaced by a pitch of 55 µm. A dynamic range of at least 4–500 keV per pixel can be achieved. Each pixel is equipped with its own preamplifier with a peaking time which is tuneable around a default value of 25 ns. The ASIC is able to measure simultaneously the Time-over-Threshold (ToT) and Time-of-Arrival (ToA) for pulses of charge detected at each pixel. The accuracy on the ToA is 1.58 ns. We present here the results obtained using a 675 µm thick sensor. The sensor, manufactured with preadout, n-bulk technology was produced and bump-bonded by ADVACAM (Finland) [8]. The depletion voltage for the sensor was 200 V. We operated the sensor at a voltage of 350 V throughout the measurements presented here. A photo of the Timepix3, as implemented in our setup, is provided in Fig. 1.



Fig. 1. Timepix3 and its chipboard, mounted on the support frame in our setup.

3.2. The GRACE beamline

The purpose of the GRACE beamline is to provide slow antiprotons of known energies, while minimizing the background produced by the annihilations of faster antiprotons. The AD delivers antiprotons in bunches of $3 \cdot 10^7$ particles at an energy of 5.3 MeV. The bunches are delivered with a slightly variable repetition rate in the order of ~100 s. In order to slow the antiprotons down to energies of a few keV thin foil moderators are used. In our case, the AD beamline is terminated

with a 50 μ m thick titanium vacuum separation foil. The GRACE entrance window is located downstream of the AD window, after a ~40 mm air grap. The entrance window is made of 25 μ m thick Ti foil. Taking into account the attenuation power of the air gap, a further 46 μ m of Al foils were necessary to moderate antiprotons to an energy of few keV. Downstream of this moderator assembly, the beam intensity is 50% of the original value (as estimated in a similar configuration in [4]), but still high enough to produce important pile-up effects in tracking detectors. For this reason we implemented in our chamber assembly an electrostatic optics system able to select the low energy antiprotons. Energy selection is also important to control the annihilation depth of the antiprotons, in our case in silicon.

The energy selection is accomplished through two einzel lenses and an electrostatic deflector. The electrostatic optics was simulated using the IBSimu (Ion Beam Simulation) package [9]. The chamber is shown in Fig. 2, along with the simulated values of the electrostatic field lines and the paths followed by 10^7 impinging antiprotons. Slow antiprotons are deflected at a 40° angle. The electrostatic deflector can be biased up to ~10 kV through a CAEN N470 HV supply. Given the bending angle (40°), the expected antiproton energy is given by $E_{kin} \simeq eV_{elec} \cos(40^\circ)$, where V_{elec} is the potential difference between the two bending electrodes.



Fig. 2. Layout of the GRACE extraction line, along with antiproton paths (red) and equipotential field lines (green).)

The number of low energy antiprotons delivered at the end of the deflection line is in the order of 100, with an anisotropic spatial distribution as shown in Fig. 3. The narrow *y* distribution was achieved by employing an asymmetric deflector, with the inner bending plate shorter in the vertical direction than the outer one, as shown in Fig. 4.



Fig. 3. Simulated spatial distribution of the antiprotons at the exit of the chamber for a total deflector voltage of 2000 V.



Fig. 4. The electrostatic deflector (foreground). In the back the first einzel lens is visible.

In order to increase the lifetime of antiprotons and avoid in-flight annihilations, the chamber is kept at a vacuum pressure better than $1 \cdot 10^{-6}$ mbar, ensuring an antiproton lifetime in the order of milliseconds.

In our chamber assembly, the detector was mounted at the end of the deflection line. Thermal management of the Timepix3 in vacuum is ensured through an electrically insulating thermal pad and the heat is sunk in the aluminum support where the Timepix3 board was mounted. This allows to operate the detector at stable temperatures lower than 70 °C. The electrical connections of the chipboard are ensured through a custom-made VHDCI vacuum feedthrough.

4. Beam characterization

We verified the correct operation of the electrostatic deflector with the Timepix3, by measuring the arrival time of the slow antiprotons as a function of the electrode's bending voltage. The deflector was operated by applying identical voltages, with opposite polarities, to the two bending electrodes. Fig. 5 shows the time distribution for the hit pixels. The first, highest, peak, common to the three distributions, is the background (mostly pions), deriving from the annihilations at the chamber entrance. The pions generated in annihilations are relativistic, hence arrive to the detector (at 1.4 m distance) in a few ns. This time is negligible compared to the width of the antiproton bunch delivered by the AD (200 ns FWHM). The following peak, one for each voltage, represents the arrival of the deflected antiprotons to the detector. Fig. 6 shows the correlation between the time-of-flight and the antiproton kinetic energy.



Fig. 5. Integrated time distribution of fired pixels for different applied deflector voltages.



Fig. 6. Time delay vs. antiproton energy.

5. Tagging of antiprotons with the Timepix3

The Timepix3 produces well defined annihilation signatures. Annihilation products produce clear tracks which are isotropically distributed. The high dynamic range of the ASIC allows correct tagging of both pion (MIPs – Minimum Ionizing Particles) and heavy fragment tracks. Fig. 7 shows a selection of events, produced by \sim 1 keV antiprotons. The average energy of annihilation products is in the range of \sim 100 MeVs [5]. At these energies, only pions are MIPs, hence it is possible to directly identify them within the observed events. Information on the kind of product can often be obtained also for highly ionizing particles, depending on the presence of a Bragg peak and the observed track length [4].



Fig. 7. Sample frames for some topologies of annihilation events. From left to right: two heavily ionizing particles with Bragg peak production, three MIPs and one heavy fragment, five heavily ionizing particles (one with a clear Bragg peak) and one MIP.

The clear signature of antiproton annihilations obtained with the Timepix3 can be used for material fragmentation studies, i.e. by interposing thin foils on the detector surface. The information on the energy of the incoming antiprotons via the TOA allows to be sure that the annihilations take place within the foil volume and not on the detector surface. Such studies will be performed in the next data taking runs.

The TOA information produced by the Timepix3 can also be exploited to obtain 3D information on the direction of the track vectors. The pixels within a single annihilation event were observed to have a TOA spread in the order of 40 ns, compatible with the carrier drift time traversing up to $675 \,\mu\text{m}$ Si thickness from the n⁺ implant to the p⁺ pixelated junctions. Moreover the far ends of the observed tracks had generally a lower TOA than the annihilations centers. This is expected from the annihilation taking place on the detector n+ side, given the low kinetic energy of the incoming antiprotons: the charge carriers generated on the far end of the detector will have to drift over the whole detector thickness. In our case the detection threshold was set at 4 keV, well below the expected charge released by a MIP in a sideways path through a 55 µm pixel (~14 keV). With MIPs-induced tracks, with relatively low values of deposited charge, the ToA for the pixels closer to the annihilation vertex (i.e. the detector backplane, where the annihilation is taking place) is comparable to the expected drift time for holes over the whole 675 µm bulk thickness. This is likely caused by the fact that the integrated charge pulse exceeds the discriminator threshold only in very close proximity of the pixel junction due to the peaking of the pixel's weighting field in this region. Knowing the applied bias and the depletion voltage and using the Jacoboni parametrization for hole mobility [10] we were able to generate a time-depth lookup table. The 3D reconstruction of one annihilation event with three pions is shown in Fig. 8. The accuracy of the z information is dependent from the accuracy in the modelling of the electric field as well as the biasing conditions of the detector (lower bias voltages corresponding to longer drift times can increase the resolution at the cost of a higher charge smearing due to diffusion effects) and has to be evaluated on a perdetector basis. However, the information (here with an estimated accuracy of 4% - calculated as ratio between the ToA resolution and the drift time) is always sufficient to unambiguously define the direction vector of the annihilation prongs.



Fig. 8. Isometric view and XY, XZ and YZ projections (left to right, top to bottom) of an annihilation event. The *z* coordinate was obtained by correlating the carrier drift time with the generation depth, as explained in the text.

6. Conclusions and outlook

We have shown results obtained using the first implementation of a new low energy antiproton extraction line implemented in the AEgIS experimental area. The simple concept of the line allows for quick mounting and implementation of setups making use of such antiprotons. The extraction line is able to provide monoenergetic antiproton beams, with a low background. Further improvements will be commissioned in the future (larger acceptance to incoming antiprotons and improved electrostatic optics), mainly in order to increase the flux.

We have employed this beamline for validating the use of the Timepix3 readout ASIC for direct annihilation detection. The ASIC, coupled with a relatively thick, 675 μ m, sensor, showed a large acceptance to annihilation fragments. Moreover we proved the capabilities of the Timepix3 as a *silicon drift chamber* when operated to detect antiproton annihilations. Its TOA resolution provides the ASIC with the unique capability of determining the depth of the antiproton annihilations and the angles at which annihilation products are emitted.

Though large datasets were acquired, their heterogenous topology will require further analysis and the results will be the subject of a dedicated publication, especially in order to define the best reconstruction strategies for the annihilation position.

Acknowledgements

This work was supported by DFG research Grant, excellence initiative of Heidelberg University, ERC under the European Unions Seventh Framework Program (FP7/2007-2013)/ ERC Grant Agreement nos. 291242 and 277762, Austrian Ministry for Science, Research and Economy,

Research Council of Norway, Bergen Research Foundation, Istituto Nazionale di Fisica Nucleare (INFN-Italy), John Templeton Foundation, Ministry of Education and Science of the Russian Federation and Russian Academy of Sciences, European social fund within the framework of realizing the project: Support of inter-sectoral mobility and quality enhancement of research teams at Czech Technical University in Prague, CZ.1.07/2.3.00/30.0034.

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